

LPC Android MC - Thermal core usage challenges in Android

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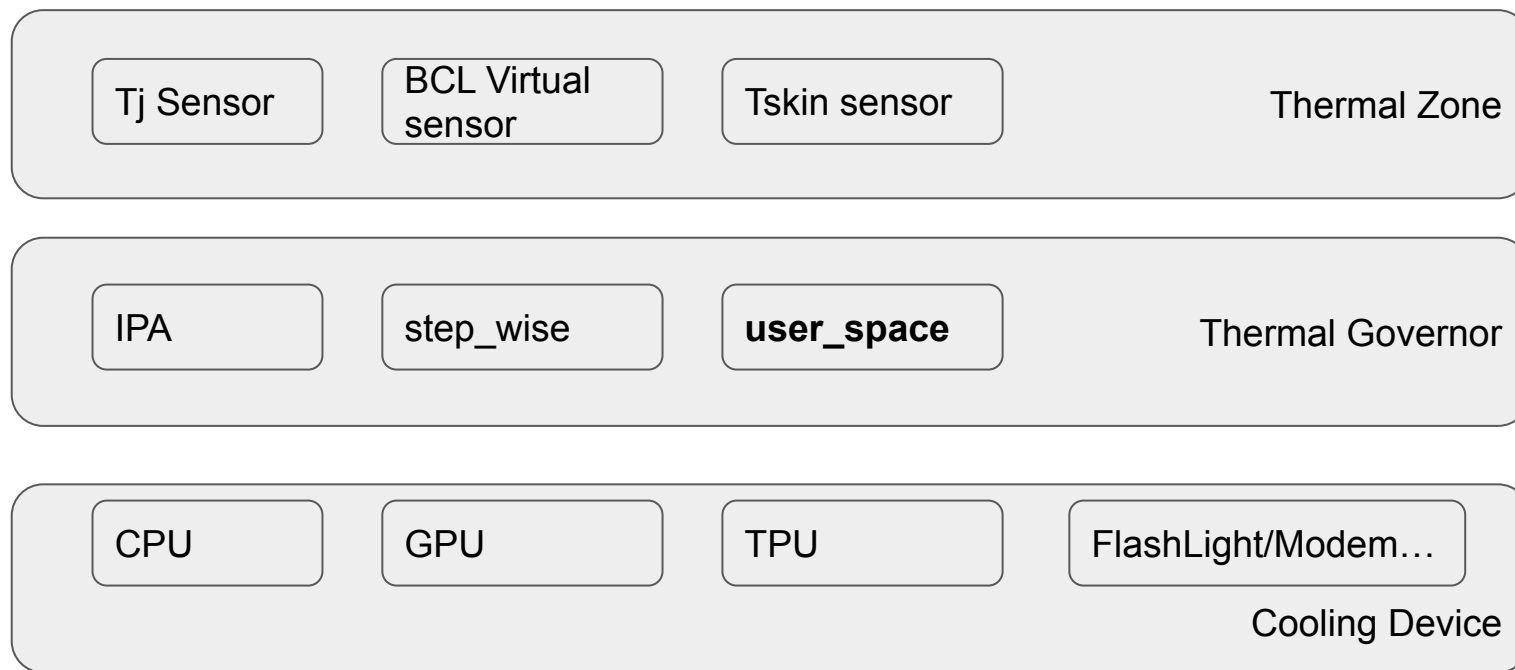


This talk is about

- Productize thermal core on Android
- Issues, pain points
- Thoughts, possible solutions

Thermal core usage in Android

- Thermal core used for both Tj and Tskin solutions.



**Problem: interaction between user_space governor
and other governors**

Sysfs interface for userspace governor

- Thermal daemon in userspace usually uses cooling device sysfs node ``cur_state`` for voting
- Same cooling device can be used by multiple thermal zones (Tj, Tskin, BCL)
- Aggregation exists between in-kernel thermal zones, but not through ``cur_state`` sysfs.
- ``temp`` sysfs in thermal zone doesn't trigger trip update.

Proposal

- Add a dedicated vote for userspace governor to aggregate votes between userspace governor and other governors.

Problem: thermal netlink configuration

Thermal netlink usage

- All thermal zones generate messages
- Userspace thermal daemon is mostly interested in those slow changing thermal zones (e.g. Tskin)
- Updates from some thermal zones (e.g. Tj) could be very spammy

Proposal

- filter or configuration on messages?

Problem: loadable governor module

Custom thermal governor

- Thermal governors are part of GKI
- No module support - all in one image -- larger code
- Things are not perfect in product
 - complex rules on different thresholds
 - combination of multiple governors
 - product workaround
 - customization is sometimes inevitable

Product workaround

- Implement thermal governor inside thermal sensor driver
 - Complex lock usage
 - Separate trip setting
 - In general, bad and inefficient code

Problem: virtual sensor support

Virtual sensor support

- Many usage of sensor fusion
 - Tskin: sensor fusion of multiple places for better correlation
 - BCL: complex rules for battery temperature, PMIC current, and other thermal zone inputs.

Thanks!